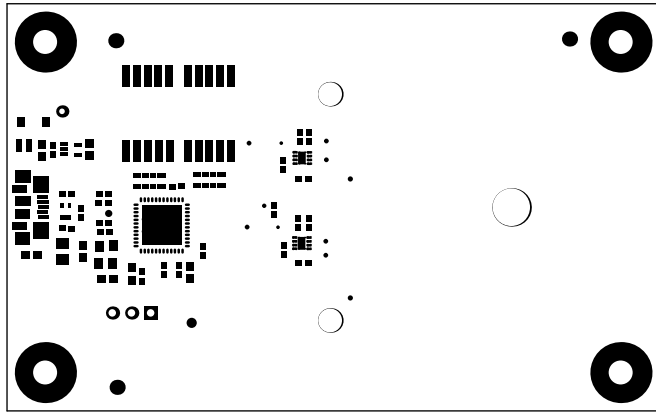
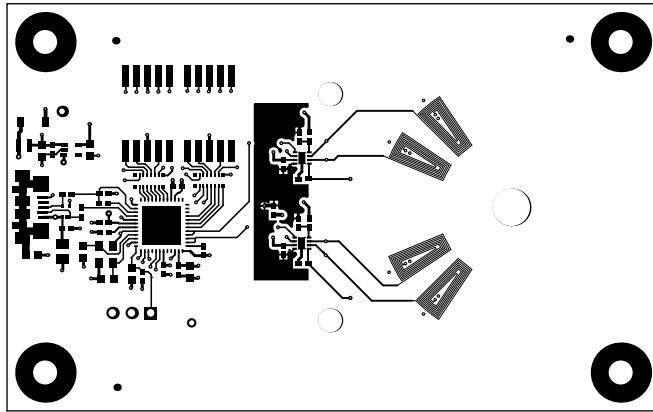


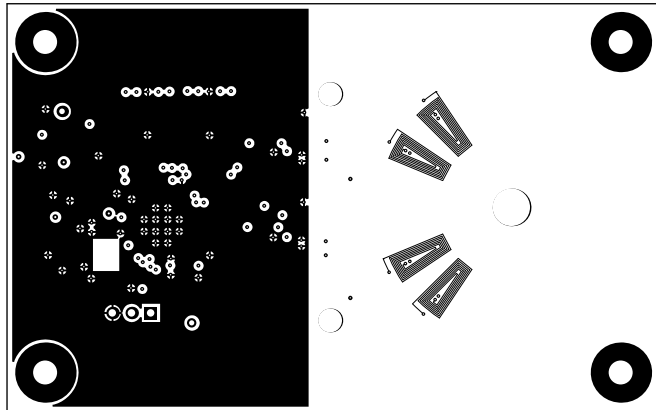
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: .TID		
PLOT NAME = Top Overlay	GENERATED : 12/16/2015 2:06:52 PM	TEXAS INSTRUMENTS	



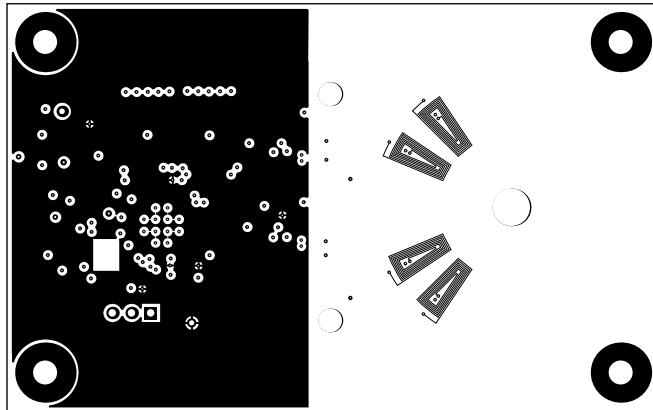
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: .TID		
PLOT NAME = Top Solder Mask	GENERATED : 12/16/2015 2:06:52 PM		TEXAS INSTRUMENTS



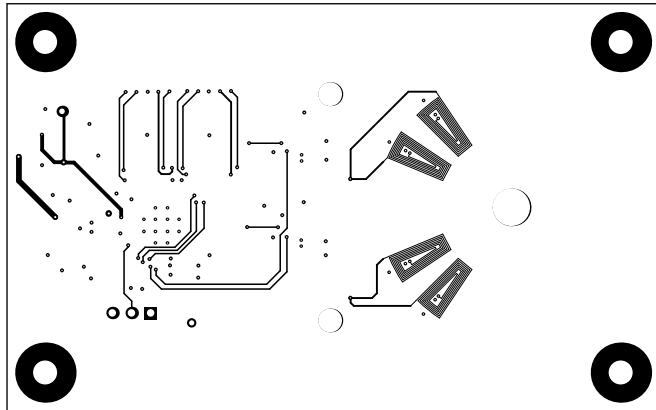
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: .TID		
PLOT NAME = Top Layer	GENERATED : 12/16/2015 2:06:53 PM		TEXAS INSTRUMENTS



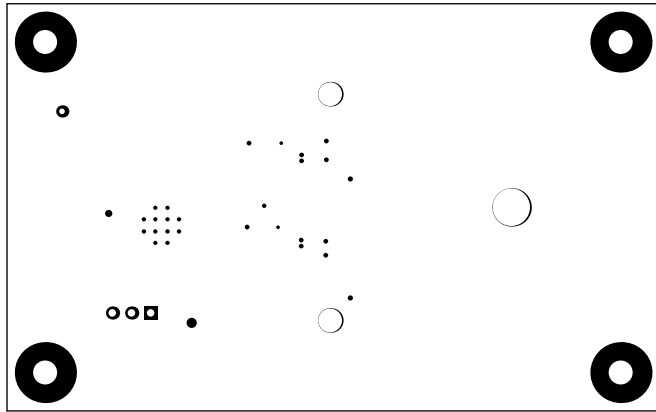
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 1	TID #: .TID		
PLOT NAME = MidLayer1	GENERATED : 12/16/2015 2:06:54 PM		TEXAS INSTRUMENTS



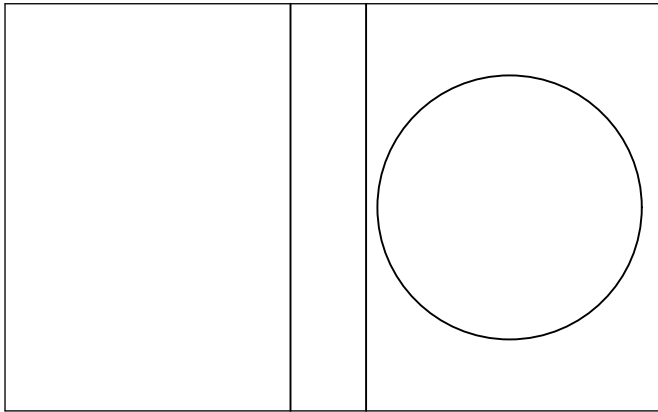
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 2	TID #: .TID		
PLOT NAME = MidLayer2	GENERATED : 12/16/2015 2:06:54 PM		TEXAS INSTRUMENTS



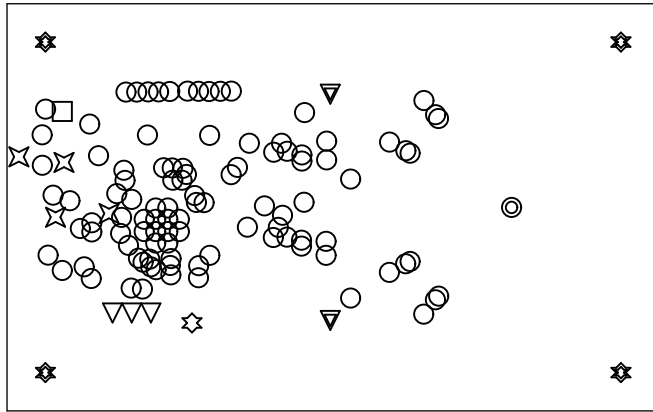
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: .TID		
PLOT NAME = Bottom Layer	GENERATED : 12/16/2015 2:06:55 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: .TID		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/16/2015 2:06:56 PM		TEXAS INSTRUMENTS

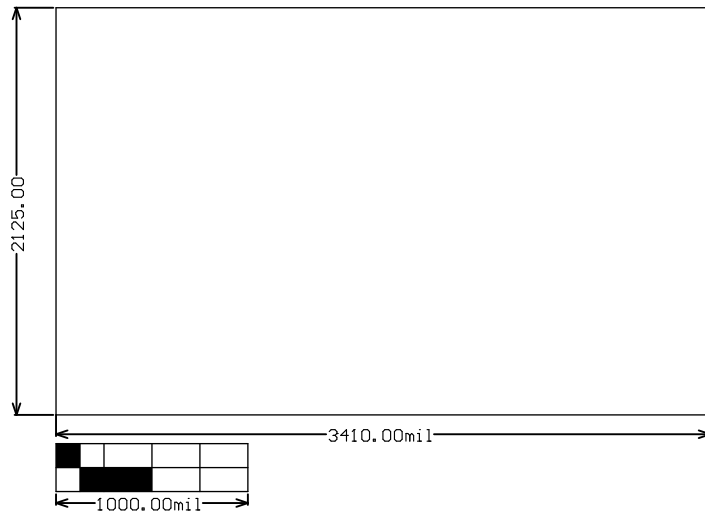


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: .TID		
PLOT NAME = Bottom Overlay	GENERATED : 12/16/2015 2:06:56 PM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▼	2	125.00mil (3.175mm)	NPTH	Round
●	1	197.00mil (5.004mm)	NPTH	Round
○	103	7.87mil (0.200mm)	PTH	Round
✕	4	12.00mil (0.305mm)	PTH	Round
☆	1	28.00mil (0.711mm)	PTH	Round
□	1	30.00mil (0.762mm)	PTH	Round
▽	3	40.00mil (1.016mm)	PTH	Round
★	4	125.98mil (3.200mm)	PTH	Round
	119 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: .TID		
PLOT NAME = Drill Drawing	GENERATED : 12/16/2015 2:06:57 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00828	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: .TID		
PLOT NAME = Board Dimensions	GENERATED : 12/16/2015 2:06:57 PM	TEXAS INSTRUMENTS	

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